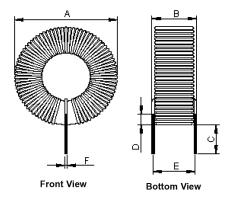
# Inductor



## **Configurations and Dimensions**



А	43mm (Max.)
В	16mm (Max.)
С	12.5 ±1mm
D	1mm (Min.)
E	13.5 ±1.5mm
F	1 ±0.1mm

#### **Test Data for Mechanical**

Test Item	A mm	B mm	C mm	D mm	E mm	F mm
Specification	43 (Max.)	16 (Max.)	12.5 ±1	1 (Min.)	13.5 ±1	1 ±0.1
1	41.62	14.57	12.59	1.75	13.78	1.01
2	41.72	14.6	12.38	1.8	13.82	1.01
3	41.82	14.62	13.01	1.54	13.88	1
4	41.9	14.59	12.75	1.68	13.82	1.02
5	41.75	14.62	13.02	1.75	13.74	1.01
Average	41.76	14.6	12.75	1.7	13.81	1.01

#### **Electrical Characteristics**

Test Condition		
10kHz / 5mA	L	560µH ±15%
TA = 25°C	DCR	77mΩ ±10% (Max.)
10kHz / 5mA Irms = 10A	ΔΤ	Temperature rise 40°C (Max.)

Operating temperature : -55°C to +130°C

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# RoHS Compliant



1. Wire UEFN/U Ø1mm (155°C)

Schematic Diagram

2. 77TS (Reference) C.W

### **Reliability Test**

Test Item	Specifications		Test M	est Method and Remarks		
Operating temperature range	-55°C to +130°C		Including temperature rise due to self-generated heat.			
Storage condition	Ambient temperature: 0°C to 40°CHumidity: Below 70% RH		To maintain the solderability of terminal electrodes, care must be taken to control temperature and humidity in the storage area.			
			According to J-STD-020B level 3			
	Appearance	: No abnormality	Test condition	: 60°C 60% RH		
Moisture		No damage	Test duration	: 40 hrs		
sensitivity	DCR change Inductance change	: Within ±5% : Within ±5%	Recovery	: 1 to 2 hours of recovery under the standard condition after the removal from the test chamber.		
	All termination shall exhibit a continuous solder coating free from defects for a minimum of 95% of the surface area of any individual lead.		According to J-STD-00	2B		
			Steam aging category	: 97°C 98% RH		
Soldorability			Steam aging duration	: 8 hrs		
Solderability			Solder	: Lead-free solder		
			Solder temperature	: 260 ±5°C		
			Dip time	: 5 +0 / -0.5s		

### Test Data for Electrical

Test Item	L µH	DCR mΩ	ΔΤ
Condition	10kHz / 5mA	at 25°C	10kHz / 5mA Irms = 10A
Specification	560 ±15%	77 ±10%	Temperature rise 40°C (Max.)
1	557.2	78.98	
2	564.5	77.41	
3	578.55	76.71	OK
4	580.8	79.07	
5	559.72	77.32	
Average	568.15	77.9	OK

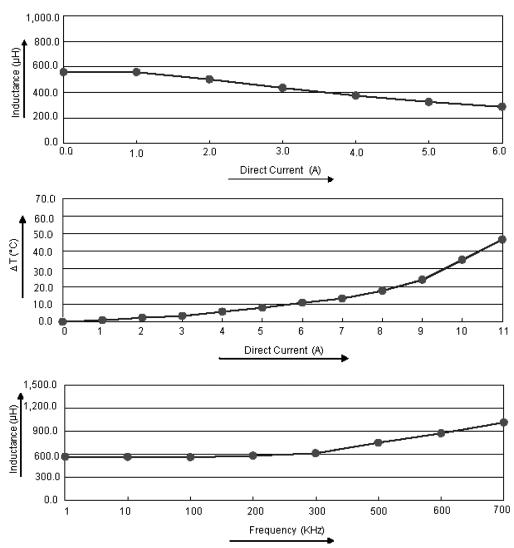
#### **Material List**

No.	ltem	Material Description
1	Core	T150-75-TAF200 (Red / White)
2	Wire	UEFN/U 1mm (155°C)
3	Solder	Sn99.3% / Cu0.7%

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# Inductor



#### **Electric Characteristics**

#### Part Number Table

Description	Part Number	
Inductor, 560µH, 15%, 2 Pins	MCAP115018077A-561LU	

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